



N 沟道增强型场效应晶体管

N-CHANNEL MOSFET

FHS110N8F5A

### 主要参数 MAIN CHARACTERISTICS

ID	120 A
VDSS	85 V
Rdson-typ ( @Vgs=10V )	5mΩ
Qg-typ	59.4nC

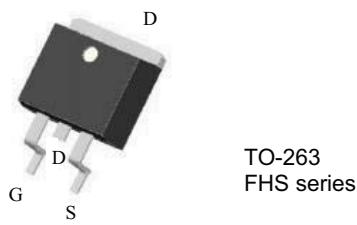
### 用途 APPLICATIONS

电池管理系统 BMS

### 产品特性 FEATURES

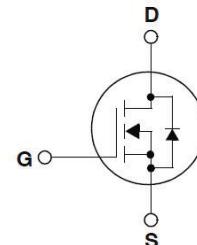
低栅极电荷	Low gate charge
低 Crss (典型值 32.4pF)	Low Crss (typical 32.4pF )
开关速度快	Fast switching
100%经过雪崩测试	100% avalanche tested
高抗 dv/dt 能力	Improved dv/dt capability
RoHS 产品	RoHS product

### 封装形式 Package



TO-263  
FHS series

### 等效电路 Equivalent Circuit



### 绝对最大额定值 ABSOLUTE RATINGS (Tc=25°C)

项目 Parameter	符号 Symbol	数值 Value	单位 Unit
		FHS110N8F5A	
最高漏极—源极直流电压 Drain-Source Voltage	VDS	85	V
连续漏极电流* Drain Current -continuous *	Id (Tc=25°C)	120	A
	Id (Tc=100°C)	80	A
最大脉冲漏极电流 (注 1) Drain Current – pulse (note 1)	IdM	480	A
最高栅源电压 Gate-Source Voltage	VGS	±20	V
单脉冲雪崩能量 (注 2) Single Pulsed Avalanche Energy (note 2)	EAS	361	mJ
雪崩电流 (注 1) Avalanche Current (note 1)	IAR	17	A
重复雪崩能量 (注 1) Repetitive Avalanche Current (note 1)	EAR	20	mJ
二极管反向恢复最大电压变化速率 (注 3) Peak Diode Recovery dv/dt (note 3)	dv/dt	5.0	V/ns
耗散功率 Power Dissipation	PD (TC=25°C)	157	W
	-Derate above 25°C	1.25	W/°C
最高结温及存储温度 Operating and Storage Temperature Range	TJ, TSTG	-55~+150	°C
引线最高焊接温度 Maximum Lead Temperature for Soldering Purposes	TL	300	°C

\*漏极电流由最高结温限制

\*Drain current limited by maximum junction temperature

## 电特性 ELECTRICAL CHARACTERISTICS

项目 <b>Parameter</b>	符号 <b>Symbol</b>	测试条件 <b>Tests conditions</b>	最小 <b>Min</b>	典型 <b>Typ</b>	最大 <b>Max</b>	单位 <b>Units</b>	
<b>关态特性 Off -Characteristics</b>							
漏—源击穿电压 Drain-Source Voltage	BVDSS	Id=250μA, VGS=0V	85	90	-	V	
击穿电压温度特性 Breakdown Voltage Temperature Coefficient	ΔBVdss/Δ TJ	Id=250μA, referenced to 25°C	-	0.08	-	V/°C	
零栅压下漏极漏电流 Zero Gate Voltage Drain Current	Idss	VDS=80V, VGS=0V, Tc=25°C	-	-	1	μA	
		VDS=64V, Tc=125°C	-	-	10	μA	
栅极体漏电流 Gate-body leakage current	IGSS (F/R)	VDS=0V, VGS =±20V	-	-	±100	nA	
<b>通态特性 On-Characteristics</b>							
阈值电压 Gate Threshold Voltage	VGS(th)	VDS = VGS , Id=250μA	2.0	-	4.0	V	
静态导通电阻 Static Drain-Source On-Resistance	RDS(ON)	VGS =10V , Id=50A	-	5	7	mΩ	
正向跨导 Forward Transconductance	gfs	VDS = 10V, Id=50A (note 4)	-	47	-	S	
<b>动态特性 Dynamic Characteristics</b>							
栅电阻 Gate Resistance	Rg	f=1.0MHz, VDS OPEN	-	2.5	-	Ω	
输入电容 Input capacitance	Ciss	VDS=40V, VGS =0V, f=1.0MHz	-	3841	-	pF	
输出电容 Output capacitance	Coss		-	651.7	-		
反向传输电容 Reverse transfer capacitance	Crss		-	34.2	-		
<b>开关特性 Switching Characteristics</b>							
延迟时间 Turn-On delay time	td(on)	VDS=40V, Id=50A, RG=3Ω VGS =10V (note 4, 5)	-	15.6	-	ns	
上升时间 Turn-On rise time	tr		-	32.7	-	ns	
延迟时间 Turn-Off delay time	td(off)		-	24.2	-	ns	
下降时间 Turn-Off Fall time	tf		-	15.1	-	ns	
栅极电荷总量 Total Gate Charge	Qg	VDS =40V , Id=50A , VGS =10V (note 4, 5)	-	59.4	-	nC	
栅—源电荷 Gate-Source charge	Qgs		-	16.5	-	nC	
栅—漏电荷 Gate-Drain charge	Qgd		-	12.3	-	nC	
<b>漏—源二极管特性及最大额定值 Drain-Source Diode Characteristics and Maximum Ratings</b>							
正向最大连续电流 Maximum Continuous Drain -Source Diode Forward Current	Is		-	-	120	A	
正向最大脉冲电流 Maximum Pulsed Drain-Source Diode Forward Current	ISM		-	-	480	A	
正向压降 Drain-Source Diode Forward Voltage	VSD	VGS=0V, Is=50A	-	0.9	1.2	V	
反向恢复时间 Reverse recovery time	trr	VGS=0V, Is=50A ,dI/dt=100A/μs (note 4)	-	64.3	-	ns	
反向恢复电荷 Reverse recovery charge	Qrr		-	152.7	-	nC	

---

## 热特性 THERMAL CHARACTERISTIC

项目 Parameter	符号 Symbol	最大值 Max	单位 Unit
结到管壳的热阻 Thermal Resistance, Junction to Case	R <sub>th(j-c)</sub>	0.8	°C/W
结到环境的热阻 Thermal Resistance, Junction to Ambient	R <sub>th(j-A)</sub>	62.5	°C/W

注释:

- 1: 脉冲宽度由最高结温限制
- 2: L=1mH, I<sub>AS</sub>=17A, V<sub>DD</sub>=48V, R<sub>G</sub>=25 Ω, 起始结温 T<sub>J</sub>=25°C
- 3: I<sub>SD</sub> ≤ 120A, di/dt ≤ 300A/μs, V<sub>DD</sub> ≤ BV<sub>DSS</sub>, 起始结温 T<sub>J</sub>=25°C
- 4: 脉冲测试: 脉冲宽度 ≤ 300μs, 占空比≤2%
- 5: 基本与工作温度无关

Notes:

- 1: Pulse width limited by maximum junction temperature
- 2: L=1mH, I<sub>AS</sub>=17A, V<sub>DD</sub>=48V, R<sub>G</sub>=25 Ω, Starting T<sub>J</sub>=25°C
- 3: I<sub>SD</sub> ≤ 120A, di/dt ≤ 300A/μs, V<sub>DD</sub> ≤ BV<sub>DSS</sub>, Starting T<sub>J</sub>=25°C
- 4: Pulse Test: Pulse Width ≤ 300μs, Duty Cycle≤2%
- 5: Essentially independent of operating temperature

## Typical Characteristics

### 典型特性曲线

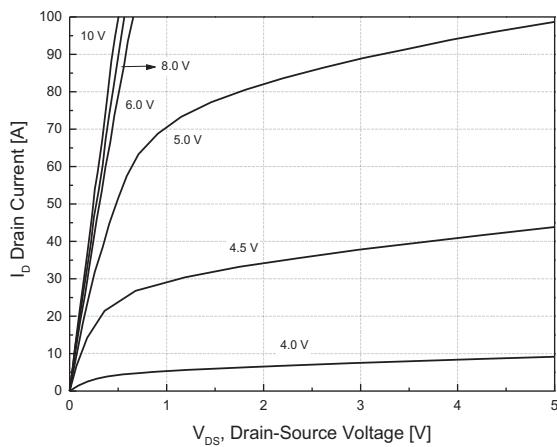


Fig.1 On-Region Characteristics

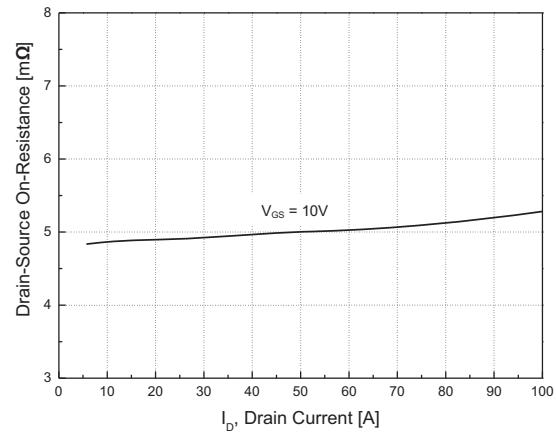


Fig.2 On-Resistance Variation with Drain Current and Gate Voltage

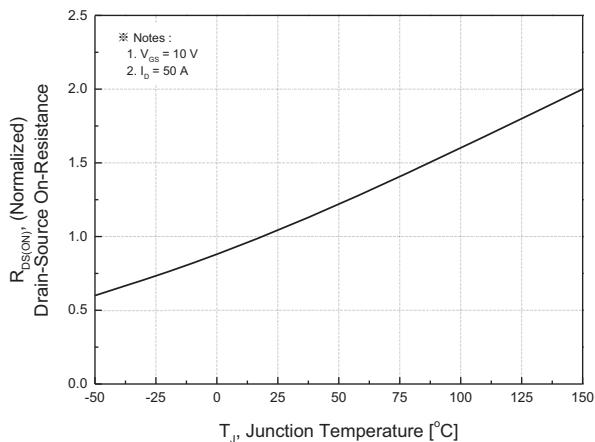


Fig.3 On-Resistance Variation with Temperature

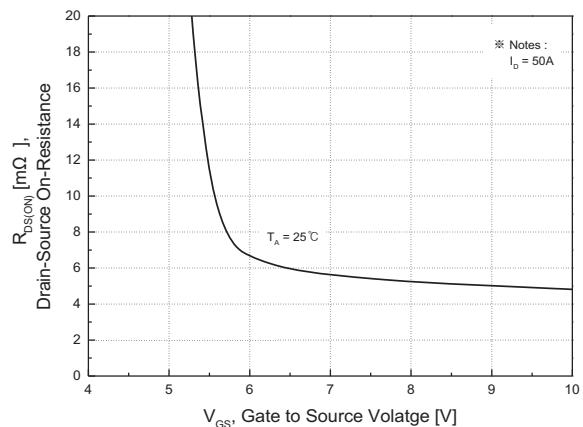


Fig.4 On-Resistance Variation with Gate to Source Voltage

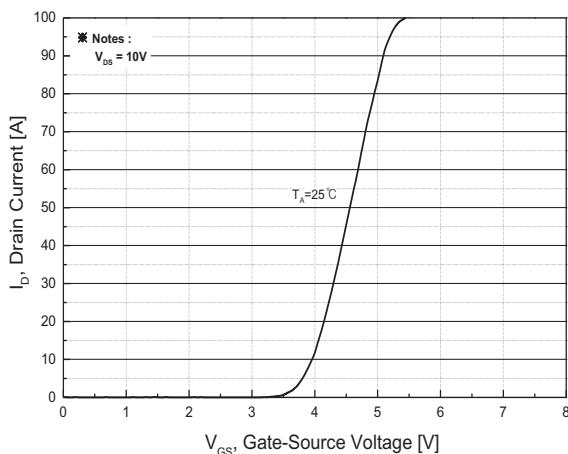


Fig.5 Transfer Characteristics

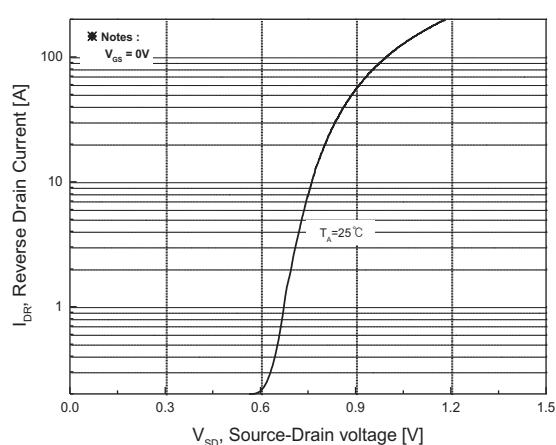
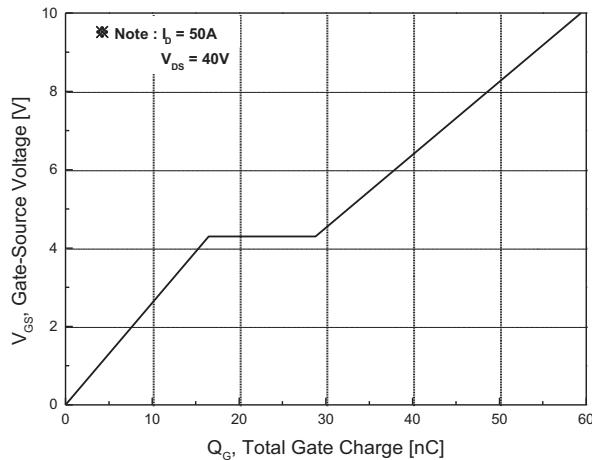


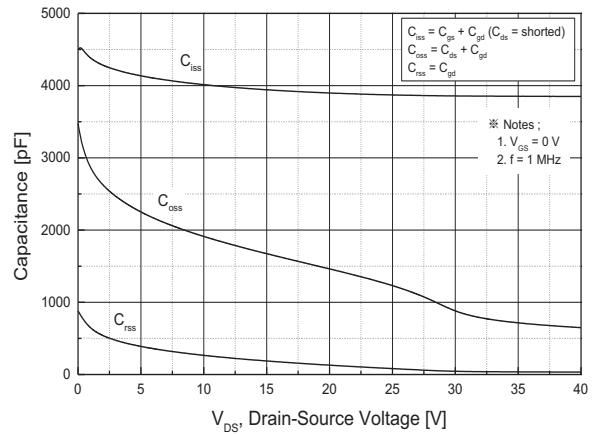
Fig.6 Body Diode Forward Voltage Variation with Source Current and Temperature

## Typical Characteristics (continued)

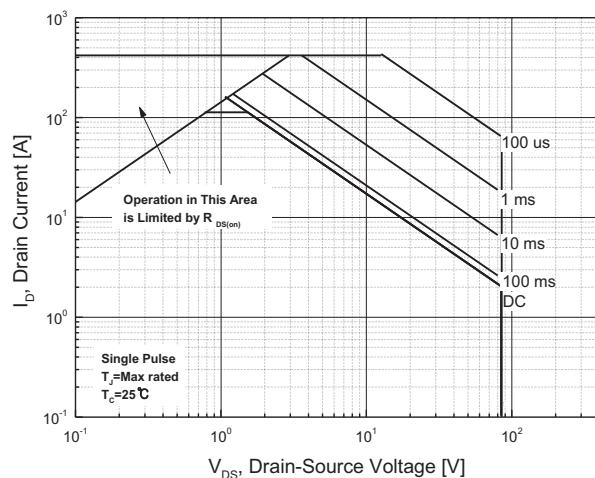
### 典型特性曲线 (续)



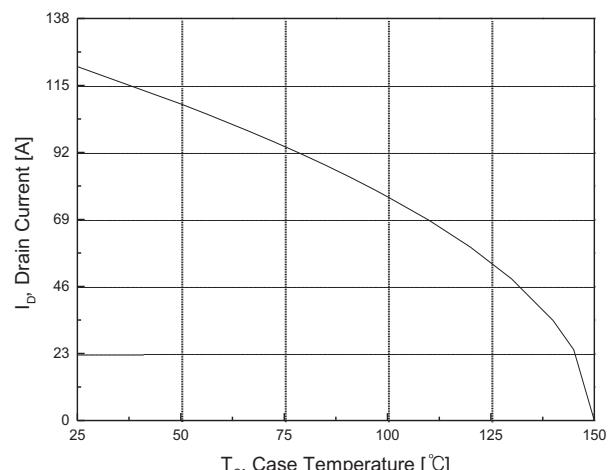
**Fig.7 Gate Charge Characteristics**



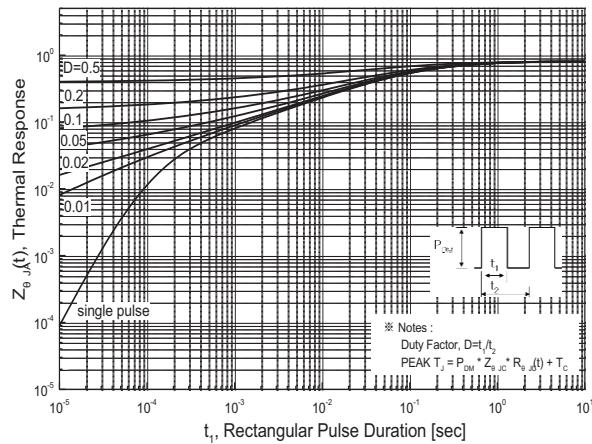
**Fig.8 Capacitance Characteristics**



**Fig.9 Maximum Safe Operating Area**



**Fig.10 Maximum Drain Current vs. Case Temperature**



**Fig.11 Transient Thermal Response Curve**

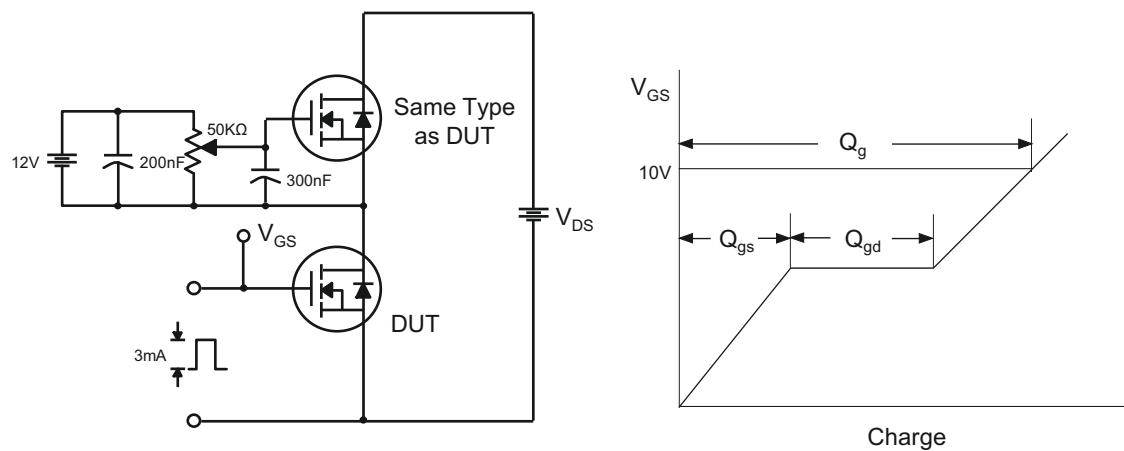


Fig 12. Gate Charge Test Circuit & Waveform

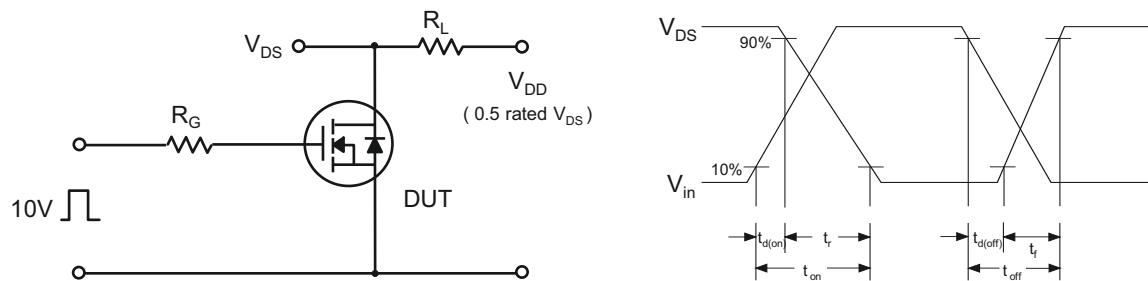


Fig 13. Resistive Switching Test Circuit & Waveforms

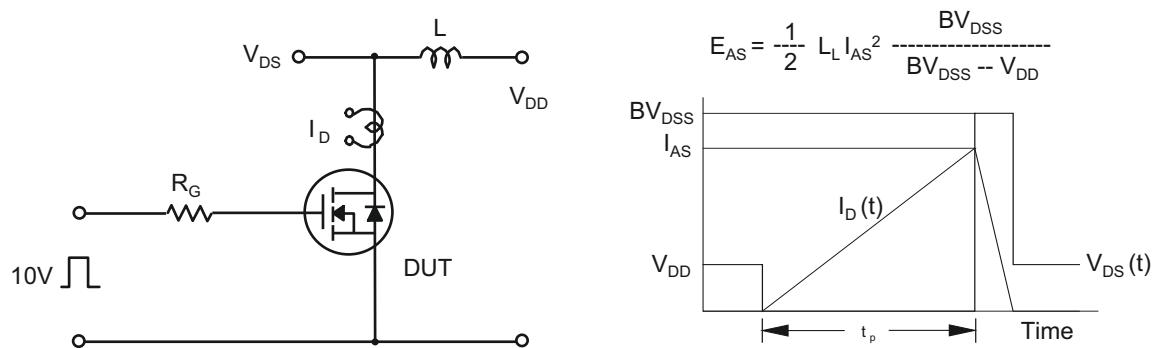


Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms

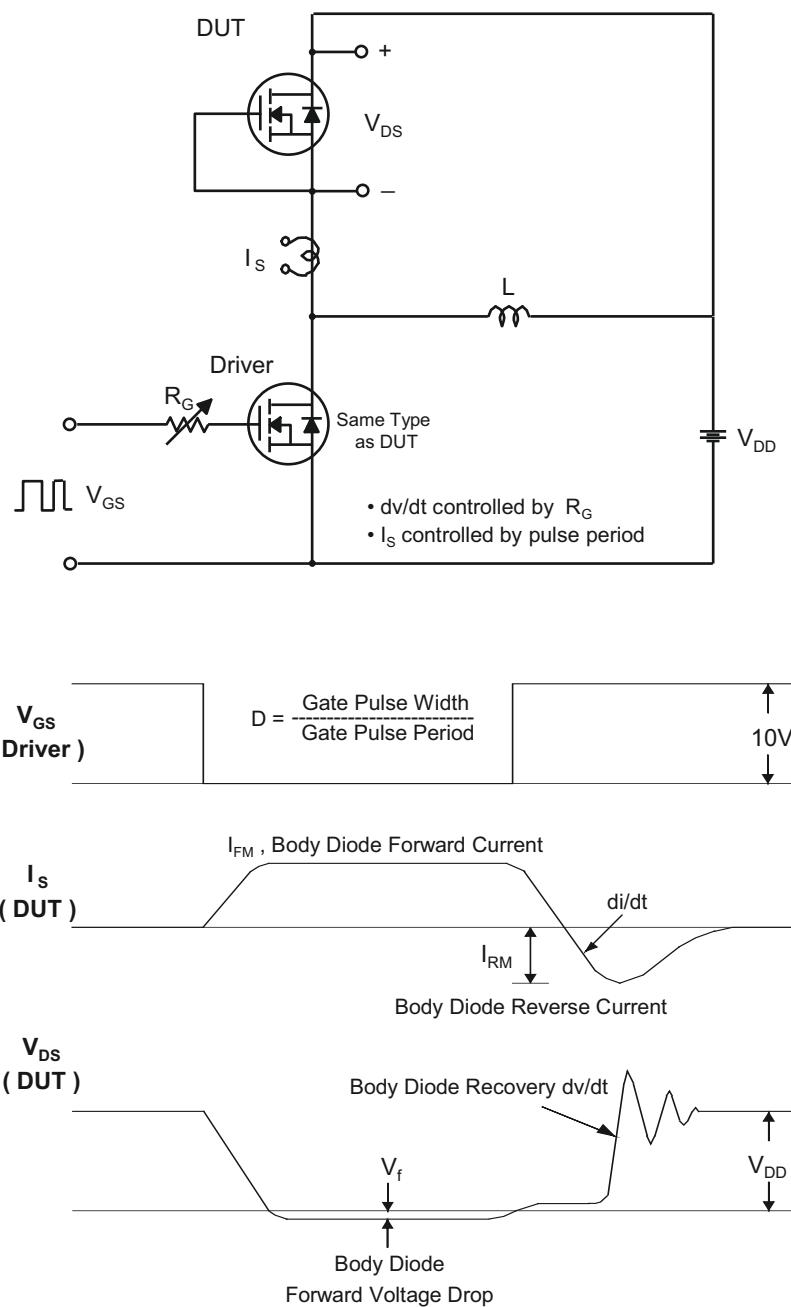
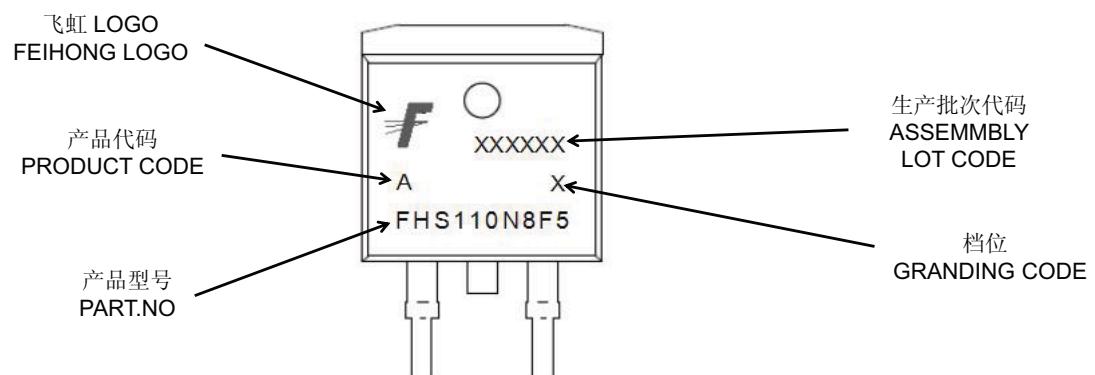


Fig 15. Peak Diode Recovery  $dv/dt$  Test Circuit & Waveforms

---

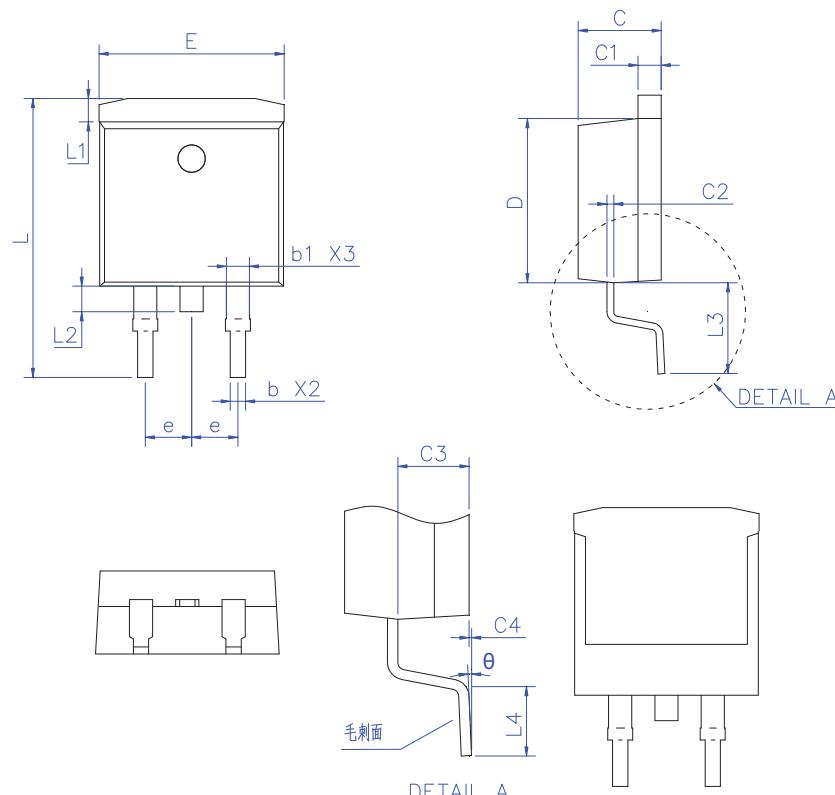
**印记 Marking:**



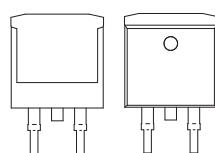
外形尺寸:

Package Dimension:

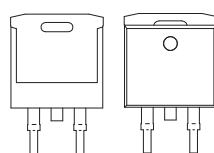
TO-263



DIM	MILLIMETERS	
	MIN	MAX
E	9.80	10.50
L	14.60	15.80
L1	1.00	1.55
L2	1.30	1.70
L3	4.50	5.50
L4	2.10	2.90
b	0.60	0.99
b1	1.00	1.50
C	4.30	4.80
C1	1.10	1.45
C2	0.25	0.52
C3	2.40	2.80
C4	0	0.25
D	8.50	9.50
θ	0°	8°
e	Typical	2.54



框架不带锁料孔



框架带锁料孔

(Unit: mm)

# X-ON Electronics

Largest Supplier of Electrical and Electronic Components

***Click to view similar products for MOSFET category:***

***Click to view products by FeiHong manufacturer:***

Other Similar products are found below :

[614233C](#) [648584F](#) [MCH3443-TL-E](#) [MCH6422-TL-E](#) [FDPF9N50NZ](#) [FW216A-TL-2W](#) [FW231A-TL-E](#) [APT5010JVR](#) [NTNS3A92PZT5G](#)  
[IRF100S201](#) [JANTX2N5237](#) [2SK2464-TL-E](#) [2SK3818-DL-E](#) [FCA20N60\\_F109](#) [FDZ595PZ](#) [STD6600NT4G](#) [FSS804-TL-E](#) [2SJ277-DL-E](#)  
[2SK1691-DL-E](#) [2SK2545\(Q,T\)](#) [D2294UK](#) [405094E](#) [423220D](#) [MCH6646-TL-E](#) [TPCC8103,L1Q\(CM](#) [367-8430-0972-503](#) [VN1206L](#)  
[424134F](#) [026935X](#) [051075F](#) [SBVS138LT1G](#) [614234A](#) [715780A](#) [NTNS3166NZT5G](#) [751625C](#) [873612G](#) [IRF7380TRHR](#)  
[IPS70R2K0CEAKMA1](#) [RJK60S3DPP-E0#T2](#) [RJK60S5DPK-M0#T0](#) [APT5010JVFR](#) [APT12031JFLL](#) [APT12040JVR](#) [DMN3404LQ-7](#)  
[NTE6400](#) [JANTX2N6796U](#) [JANTX2N6784U](#) [JANTXV2N5416U4](#) [SQM110N05-06L-GE3](#) [SIHF35N60E-GE3](#)